

L Number	Hits	Search Text	DB	Time stamp
1	31	substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:15
2	0	((substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and dimension near\$3 pattern	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:25
4	31	((substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and process\$3 near monitor\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:16
5	13	((substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and process\$3 near monitor\$3	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:16
6	6	((substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and process\$3 near monitor\$3) and dimension	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:20
7	0	10/646943	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:22
8	257	michael near barnes	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:24
9	0	hollan near john	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:24
10	334	holland near john	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:25
11	0	((substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and holland near john	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:25
12	0	((substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and process\$3 near monitor\$3) and holland near john	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:26
13	1	((substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and shan near hongqing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:27

14	0	(michael near barnes) and (substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:27
15	1	(substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and bryan near pu	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:28
16	0	(substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and jain near mohit	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:29
17	10	jain near mohit	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:29
18	0	sui near zhifeng and (substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:29
19	9	sui near zhifeng	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:30
20	42	armacost near michael	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:30
21	0	(armacost near michael) and (substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:31
22	0	hanson near neil and (substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:31
23	3	hanson near neil	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:32
24	44	ma near diana near xiaobing	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:32
25	0	(ma near diana near xiaobing) and (substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust))	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:32

26	0	(substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and sinha near ashok	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:33
3	12	(substrate near process\$3 and chamber and gas near (distributor and energiz\$2 and exhaust)) and dimension	USPAT; US-PGPUB; EPO; JPO; DERWENT; IBM_TDB	2004/07/19 20:33